



A Product Line of Diodes Incorporated

DMP4025LSD

40V DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub> max (A) T <sub>A</sub> = +25°C
-40V	25mΩ @ V <sub>GS</sub> = -10V	-7.6
-40V	45mΩ @ V <sub>GS</sub> = -4.5V	-6.0

#### Description

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

- Motor Control
- Backlighting
- DC-DC Converters
- Printer Equipment

#### **Features and Benefits**

- Low R<sub>DS(on)</sub> Minimizes conduction losses
- Fast switching speed Minimizes switching losses
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

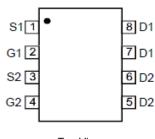
#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)

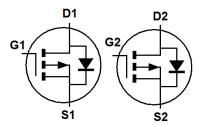


SO-8

Top View



Top View Pin-Out



Device symbol

#### Ordering Information (Notes 4 & 5)

Part Number	Compliance	Case	Packaging
DMP4025LSD-13	Standard	SO-8	2500 / Tape & Reel
DMP4025LSDQ-13	Automotive	SO-8	2500 / Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_grade\_definitions/.

#### **Marking Information**



D11 = Manufacturer's Marking
P4025LD = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 10 = 2010)
WW = Week (01 - 53)



# DMP4025LSD

#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V <sub>DSS</sub>	-40	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V	
Continuous Drain Current V <sub>GS</sub> = -10V		(Notes 7 & 9)		-7.6	
	V <sub>GS</sub> = -10V	T <sub>A</sub> = +70°C (Notes 7 & 9)		-6.1	
		(Notes 6 & 9)	ID	-5.8	
		(Notes 6 & 10)		-6.9	A
Pulsed Drain Current	V <sub>GS</sub> = -10V	(Notes 8 & 9)	I <sub>DM</sub>	-28.0	
Continuous Source Current (Body diode)		(Notes 7 & 9)	IS	-3.0	
Pulsed Source Current (Bod	y diode)	(Notes 8 & 9)	I <sub>SM</sub>	-28.0	

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	;	Symbol	Value	Unit
Power Dissipation Linear Derating Factor	(Notes 6 & 9)		1.25 10	
	(Notes 6 & 10)	PD	1.8 14.3	W mW/°C
	(Notes 7 & 9)		2.14 17.2	
	(Notes 6 & 9)		100	
Thermal Resistance, Junction to Ambient	(Notes 6 & 10)	R <sub>0JA</sub>	70	0000
	(Notes 7 & 9)		58	°C/W
Thermal Resistance, Junction to Lead	(Notes 9 & 11)	R <sub>0JL</sub>	51	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes: 6. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

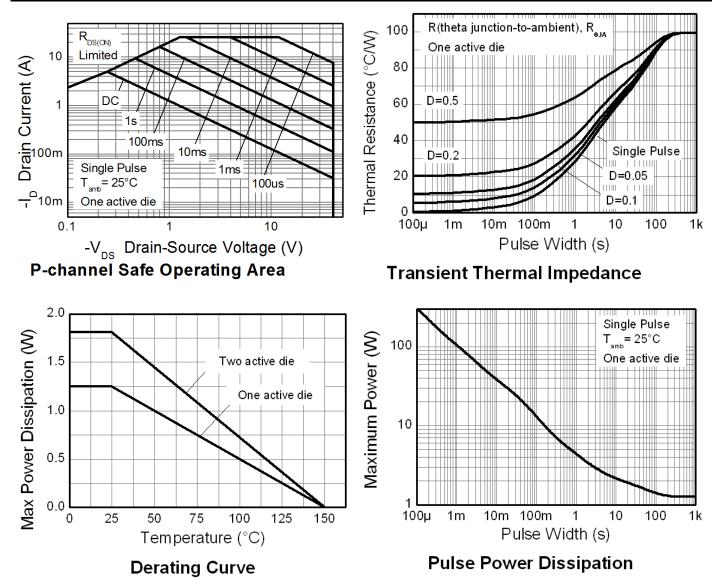
7. Same as note (2), except the device is measured at t  $\leq$  10 sec. 8. Same as note (2), except the device is pulsed with D = 0.02 and pulse width 300µs.

9. For a dual device with one active die.

For a device with two active die running at equal power.
 Thermal resistance from junction to solder-point (at the end of the drain lead).



# **Thermal Characteristics**





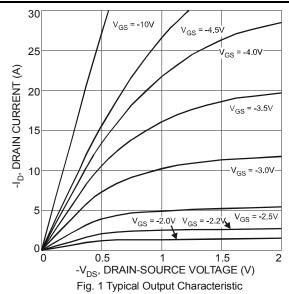


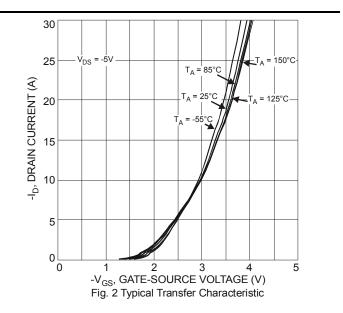
DMP4025LSD

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS			•	•				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-40	_	_	V	$I_D$ = -250µA, $V_{GS}$ = 0V		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-1.0	μA	V <sub>DS</sub> = -40V, V <sub>GS</sub> = 0V		
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS}$ = ±20V, $V_{DS}$ = 0V		
ON CHARACTERISTICS								
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.8	-1.3	-1.8	V	I <sub>D</sub> = -250 μA, V <sub>DS</sub> = V <sub>GS</sub>		
Static Drain-Source On-Resistance (Note 12)	P		18	25	mΩ	V <sub>GS</sub> = -10V, I <sub>D</sub> = -3A		
	R <sub>DS (ON)</sub>	_	30	45	11152	V <sub>GS</sub> = -4.5V, I <sub>D</sub>	= -3A	
Forward Transconductance (Notes 12 & 13)	9fs	_	16.6	_	S	V <sub>DS</sub> = -5V, I <sub>D</sub> = -3A		
Diode Forward Voltage (Note 12)	V <sub>SD</sub>	_	-0.7	-1.0	V	I <sub>S</sub> = -1A, V <sub>GS</sub> = 0V		
DYNAMIC CHARACTERISTICS (Note 13)								
Input Capacitance	C <sub>iss</sub>	—	1640	—				
Output Capacitance	C <sub>oss</sub>	—	179	—	pF	$v_{DS} = -20V, V_{C}$ f = 1MHz	-20V, V <sub>GS</sub> = 0V	
Reverse Transfer Capacitance	C <sub>rss</sub>		128	—				
Gate Resistance	Rg	_	6.43	_	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz		
Total Gate Charge (Note 14)	Qg	_	14.0	_		V <sub>GS</sub> = -4.5V	V <sub>DS</sub> = -20V I <sub>D</sub> = -3A	
Total Gate Charge (Note 14)	Qg	_	33.7	_	nC			
Gate-Source Charge (Note 14)	Q <sub>gs</sub>	_	5.5	_		V <sub>GS</sub> = -10V		
Gate-Drain Charge (Note 14)	Q <sub>gd</sub>	_	7.3	_				
Turn-On Delay Time (Note 14)	t <sub>D(on)</sub>	_	6.9	_				
Turn-On Rise Time (Note 14)	tr		14.7	_	V <sub>DD</sub> = -20V, V <sub>GS</sub> = -1		<sub>SS</sub> = -10V	
Turn-Off Delay Time (Note 14)	t <sub>D(off)</sub>	_	53.7	_	ns	ns $I_D = -3A$		
Turn-Off Fall Time (Note 14)	t <sub>f</sub>	_	30.9	_	1			

12. Measured under pulsed conditions. Pulse width  $\leq$  300µs; duty cycle  $\leq$  2% 13. For design aid only, not subject to production testing. 14. Switching characteristics are independent of operating junction temperatures. Notes:

### **Typical Characteristics**

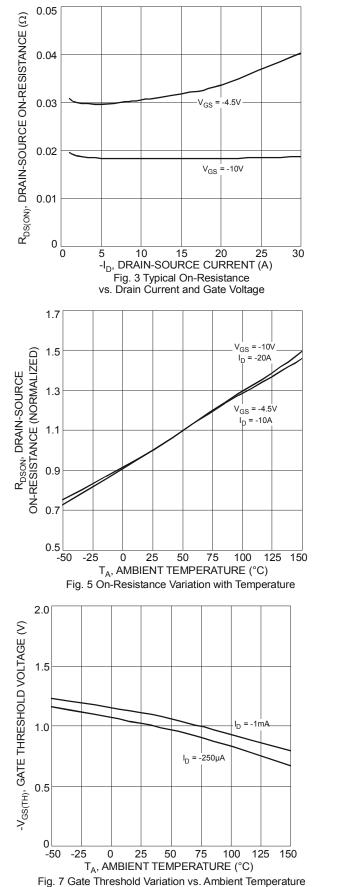


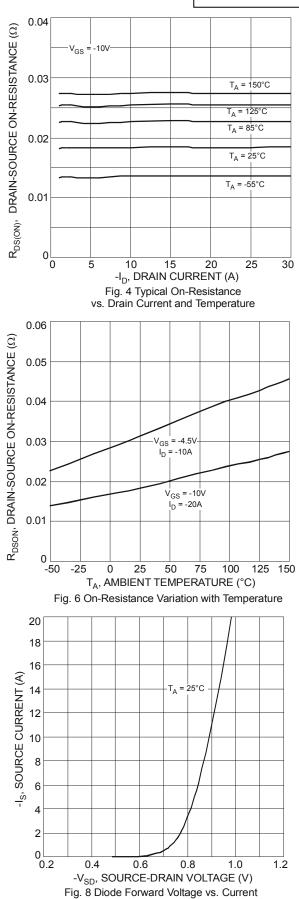




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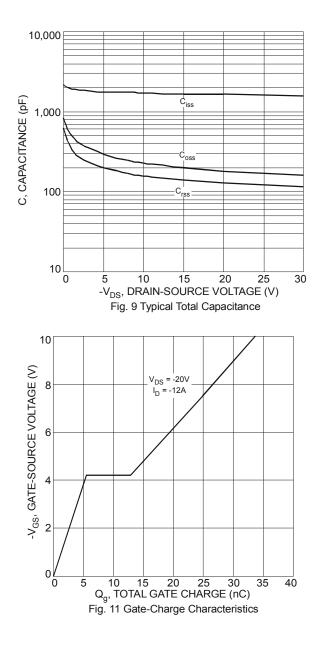


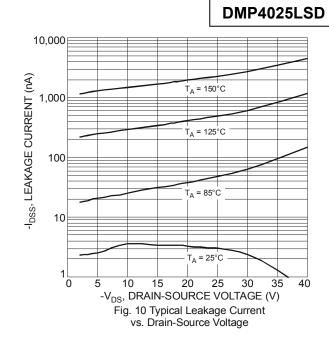




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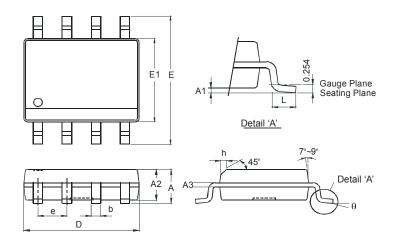






#### **Package Outline Dimensions**

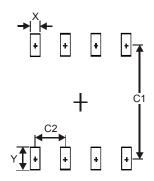
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8				
Dim	Min	Max		
Α	-	1.75		
A1	0.10	0.20		
A2	1.30	1.50		
A3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
E	5.90	6.10		
E1	3.85	3.95		
е	1.27 Typ			
h	-	0.35		
L	0.62	0.82		
θ	0°	8°		
All Di	All Dimensions in mm			

#### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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